



102696740

To the Honorable Commissioner for Patents : Please record the attached original documents or copy thereof.

Name of conveying party(ies):

- 1. Gerhard Holzapfel
- 2. Raimund Schindler

3-1504

(Additional name(s) of conveying party(ies) attached) Yes No

2. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

Execution Date: December 12, 2002 for 1, December 16, 2002 for 2.

1. Name and address of receiving party(ies):

Name: Infineon Technologies AG

Street Address: St. -Martin-Strasse 53

City: Muenchen

State: Germany

ZIP: 81669

Additional name(s) & address(es) attached Yes No

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MARCH 13 2004
COMMERCIAL SECTION

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

10/314,175

B. Patent No.(s)

Additional numbers attached Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Lerner and Greenberg

Internal Address:

Street Address: P.O. Box 2480

City: Hollywood

State: FL

ZIP: 33022

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41)\$ 40.00

- Enclosed
- Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

RALPH E. LOCHER
REG. NO. 41.947

Name of Person Signing

Signature

March 12, 2004

Date

Total number of pages including cover sheet, attachments, and document:

3

Mail documents to be recorded with required cover sheet information to:

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Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

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Docket No.: MAS-FIN-384

ASSIGNMENT

WHEREAS WE, GERHARD HOLZAPFEL and RAIMUND SCHINDLER, residing respectively at RAIN and BAD ABBACH, Germany, have invented certain new and useful improvements in a

SEMICONDUCTOR CHIP ASSEMBLY SYSTEM WITH A SUCTION NIPPLE FOR REMOVING A SEMICONDUCTOR CHIP

for which an application for Letters Patent of the United States of America was executed on the date of execution of this assignment;

WHEREAS, INFINEON TECHNOLOGIES AG, a German corporation doing business at München, Germany, is desirous of acquiring the entire interest in said invention, and in any and all Letters Patent of the United States that may be obtained therefor;

NOW, THEREFORE, be it known that for and in consideration of our employment by the said corporation and other valuable consideration, the receipt and sufficiency whereof are hereby acknowledged, we have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said corporation, its legal representatives, successors and assigns, the full and exclusive right to the said invention as fully set forth and described in the above-mentioned application, and to said application and any and all divisions and continuations thereof, and any and all Letters Patent of the United States which may be granted therefor, and any and all reissues of said Letters Patent, the same to be held and enjoyed by the said corporation, its legal representatives, successors and assigns, to the full end of the term for which said Letters Patent may be granted or may be reissued or extended, as fully and entirely as the same would have been held by us had this assignment and sale not been made.

AND WE hereby authorize the Commissioner of Patents to issue any and all Letters Patent of the United States on said invention or resulting from said Application and from any and all divisions and continuations thereof to the said corporation as the assignee of the entire right, title and interest in and to the same.

IN TESTIMONY WHEREOF, we have hereunto set our hands and seals.

In the presence of:

Ingrid Orwig
Witness

 (LS)
GERHARD HOLZAPFEL

12.12.02
Date

Witness

RAIMUND SCHINDLER (LS)

Date

